<b>PCN Number:</b> 20200108000	PC	N Date:	Jan.	9, 202	0	
Title: Datasheet for CC2640R2F						
<b>Customer Contact:</b> PCN Manager			De	ot:	Quality Services	
Change Type:					,	
	Design			Wafer	Bump Site	
	Data Sheet				Bump Material	
	Part number c	hange	H		Bump Process	
	Test Site	inarige	H		Fab Site	
	Test Process		H		Fab Materials	
Wafer Fab P						
Notification Details						
Description of Change:						
	uncing an info	armation on	lv no	tificatio	<u> </u>	
Texas Instruments Incorporated is announced to have detached to have been supported in the product detached to have bee				uncauc	и.	
The product datasheet(s) is being updat.		rized below.				
The following change history provides fu	irtiler details.					
Maria Commence						
TEXAS INSTRUMENTS					CC2640R2F	
INSTRUMENTS		SWRS2	204B – D	ECEMBER	2016-REVISED JANUARY 2020	
Changes from Revision A (January 2017) to Rev	ricion P				Page	
Changed Section 1.1. Added pin-to-pin com     Changed Section 1.2.						
	Changed Section 1.2     Changed Section 1.3     2					
Deleted Typical Flash Memory Available for						
Changed footnote (2) in Table 3-1						
Changed TYP value for Idle in Section 5.4						
Changed TYP value for Peripheral power domain in Section 5.4						
	Added footnote in Section 5.5      Observed MAX value for Data sets are allowed in Section 5.6					
<ul> <li>Changed MAX value for Data rate error tolerance in Section 5.6</li> <li>Changed TYP value for restricted bands FCC in Section 5.7</li> </ul>						
Changed TYP value for restricted bands FC						
Changed TYP value for Out-of-band blocking, 3000 MHz to 12.75 GHz in Section 5.10						
Changed TYP value for restricted bands FCC in Section 5.11						
Changed TYP value for Receiver sensitivity in Section 5.12.						
Changed TYP value for Receiver saturation in Section 5.12.      Changed TYP value for received bands ECC in Section 5.13.						
<ul> <li>Changed TYP value for restricted bands FCC in Section 5.13</li> <li>Changed TYP value for Temperature coefficient in Section 5.17</li> </ul>						
Changed TYP value for SFDR, VDDS as reference in Section 5.18						
Changed TYP value for Offset in Section 5.22						
-						
The datasheet revision number will be cl	hanging.					
Device Family	Change From	m:		Change	e To:	
	014/0.000.44			CIMPOS	20.45	
CC2640R2F	SWRS204A			SWRS2	204B	
These changes may be reviewed at the o	datasheet link	provided.				
,						
http://www.ti.com/product/CC2640R2F						
Reason for Change:						
To accurately reflect device characteristi	ics.					
To decaracely remote device and december						
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):						
No anticipated impact. This is a datashed	et specificatio	n change ar	moul	icemer	it only. There are no	
changes to the actual device.		this DON				
Changes to product identification re	suiting from	tnis PCN:				
None.						

Product Affected:			
CC2640R2FRGZR	CC2640R2FRGZT	CC2640R2FRHBR	CC2640R2FRHBT
CC2640R2FRSMR	CC2640R2FRSMT	CC2640R2FYFVR	CC2640R2FYFVT

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